

| REV | DESCRIPTION | BY | DATE |
|-----|-----------------------------|----|----------|
| A | Added position 1 indicators | BC | 06-03-03 |
| | | | |
| | | | |

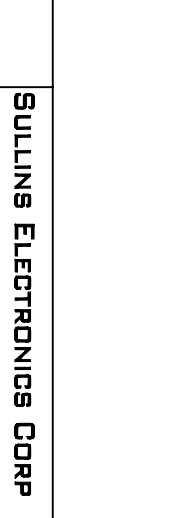
MATERIAL
 INSULATOR: GLASS-REINFORCED THERMOPLASTIC,
 U194V-0 RATED.
 CONTACT: COPPER ALLOY.
 PLATING: MATING AREA- GOLD,
 SOLDER AREA- TIN/LEAD.

ELECTRICAL
 VOLTAGE RATING: 250 VAC RMS.
 CURRENT RATING: 3 AMP.
 INSULATION RESISTANCE: 1,000 MEGOHMS MIN.
 CONTACT RESISTANCE: 30 MILLIOHMS MAX.

MECHANICAL
 CONTACT RETENTION: 460 GRAMS MIN PER CONTACT.
 INSERTION FORCE: 230 GRAMS MAX PER CONTACT PAIR.
 WITHDRAWAL FORCE: 15 GRAMS MIN PER CONTACT PAIR

ENVIRONMENTAL
 TEMPERATURE RANGE: -55° TO +85°.
 NO PART MARKINGS

GOLD PLATING
 REPLACE "x" IN THE PART NUMBER:
 W = SELECTIVE GOLD FLASH
 Z = SELECTIVE 100μ" GOLD
 X = SELECTIVE 30μ" GOLD



RECOMMENDED PCB LAYOUT

| | | |
|-----------|-----------|--------|
| X ± | X* ± 1* | FINISH |
| X ± 0.10 | X* ± 0.5* | |
| XX ± 0.05 | XX* ± | QTY |
| XXX ± | XXX* ± | |

| UNITS | MM | NAME (INTENDED USE) | TITLE: |
|-------|----|-------------------------|---------------------------------|
| MAT'L | | PART NO. (INTENDED USE) | SULLINS ELECTRONICS CORP |
| | | APPD: | 64 BIT PCI CARDEDGE, 3.3V |
| | | CHKD: | PART NO. TRXB092DKHN-T330/T26 |
| | | DRWN: N. Doanue | SCALE NONE |
| | | 9/23/97 | SHEET 1 OF 1 |
| | | | REV A |

1 2 3 4 5 6 7 8